



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

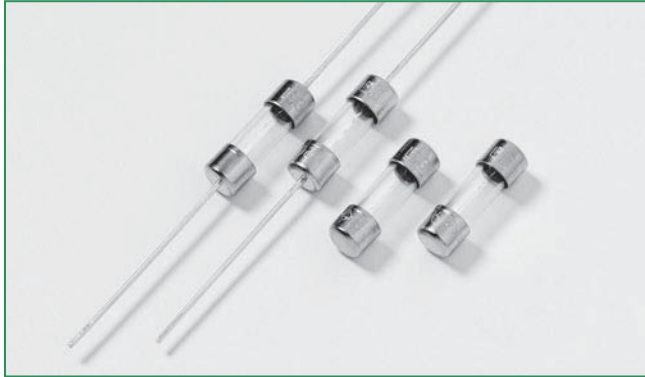
Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China



RoHS  **224/225 Series** Lead-Free 2AG, Fast-Acting



Description

The 2AG Fast-Acting Fuses are available in cartridge form or with axial leads. 2AG Fuses provide the same performance characteristics as their 3AG counterpart, while occupying one-third the space. Sleeved fuses are available.






Features

- In accordance with underwriter's Laboratories Standard UL 248-14
- Available in cartridge and axial lead form and with various forming dimensions
- RoHS compliant and Lead-free

Applications

Used as supplementary protection in appliance or utilization equipment to provide individual protection for components or internal circuits.






Agency Approvals

Agency	Agency File Number	Ampere Range
	E10480	100mA - 3.5A
	E10480	4A - 10A
	LR 29862	100mA - 10A
	NBK200405-E10480 NBK060405-E10480	Cartridge: 1A - 10A Pigtail: 1A - 10A
		100mA - 10A

Electrical Characteristics for Series

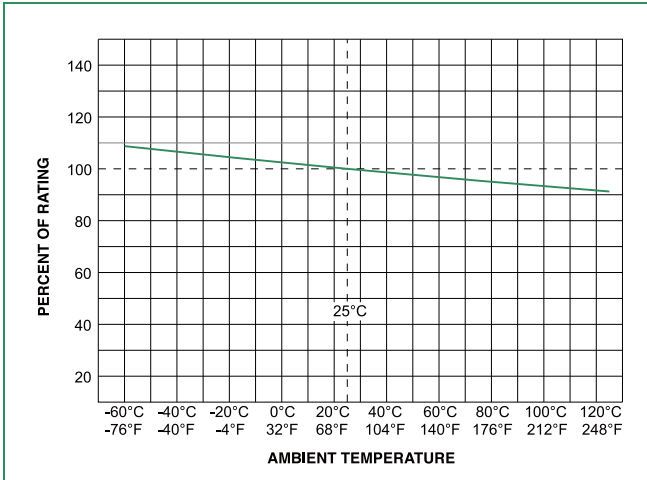
% of Ampere Rating	Opening Time
100%	4 hours, Minimum
135%	1 hour, Maximum
200%	1 sec., Maximum

Electrical Characteristic Specifications by Item

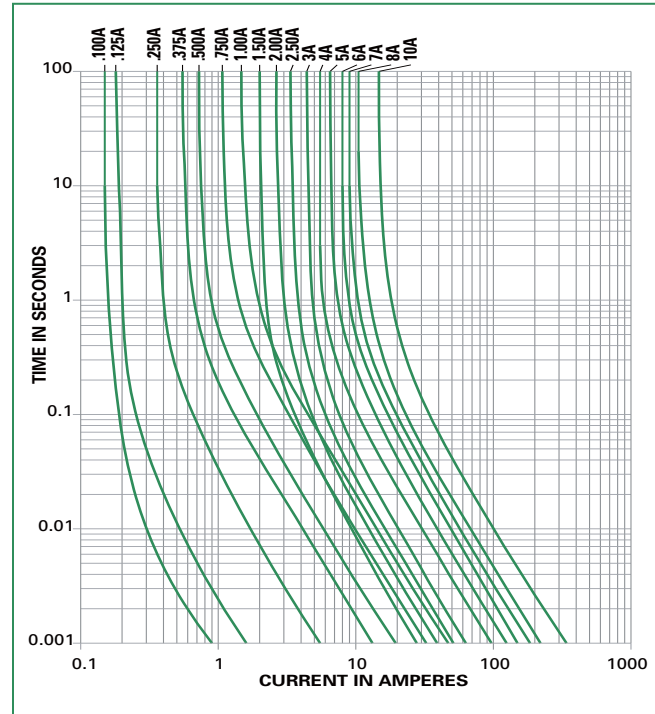
Amp Code	Ampere Rating (A)	Voltage Rating (V)	Interrupting Rating	Nominal Cold Resistance (Ohms)	Nominal Melting I ² t (A ² sec)	Agency Approvals					
											
.100	.1	250	35A@250Vac 10KA@125Vac 10KA@125Vdc	6.1500	0.00075	x		x		x	
.125	0.125	250		3.9000	0.00286	x		x		x	
.250	0.25	250		1.1500	0.0300	x		x		x	
.375	0.375	250		0.3950	0.171	x		x		x	
.500	0.5	250		0.2650	0.365	x		x		x	
.750	0.75	250		0.1520	1.050	x		x		x	
001.	1	250	100A@250Vac 10KA@125Vac 10KA@125Vdc	0.1027	2.220	x		x	x	x	
01.5	1.5	250		0.0712	0.800	x		x	x	x	
002.	2	250		0.0497	1.500	x		x	x	x	
02.5	2.5	250		0.0372	2.680	x		x	x	x	
003.	3	250		0.0317	4.620	x		x	x	x	
03.5	3.5	250		0.0265	6.700	x		x	x	x	
004.	4	125		100A@250Vac 500A@125Vac	0.0240	9.400		x	x	x	x
005.	5	125			0.0186	17.0		x	x	x	x
005.	5	250			0.0186	17.0		x	x		x
006.	6	125			0.0154	22.1		x	x	x	x
007.	7	125	500A@125Vac	0.0130	40.0		x	x	x	x	
008.	8	125		0.0107	56.0		x	x	x	x	
010.	10	125		0.0075	116.0		x	x	x	x	

* 10A with 500A @ 125 Vdc internal breaking capacity testing.

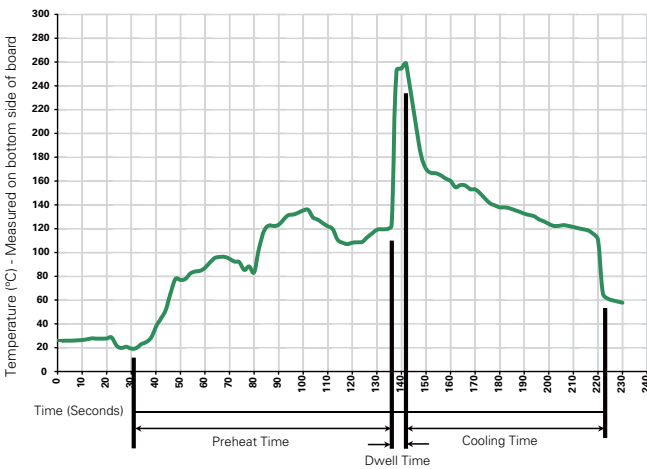
Temperature Derating Curve



Average Time Current Curves



Soldering Parameters - Wave Soldering



Recommended Process Parameters:

Wave Parameter	Lead-Free Recommendation
Preheat: (Depends on Flux Activation Temperature) (Typical Industry Recommendation)	
Temperature Minimum:	100° C
Temperature Maximum:	150° C
Preheat Time:	60-180 seconds
Solder Pot Temperature:	260° C Maximum
Solder Dwell Time:	2-5 seconds

Recommended Hand-Solder Parameters:

Solder Iron Temperature: 350° C +/- 5° C
 Heating Time: 5 seconds max.

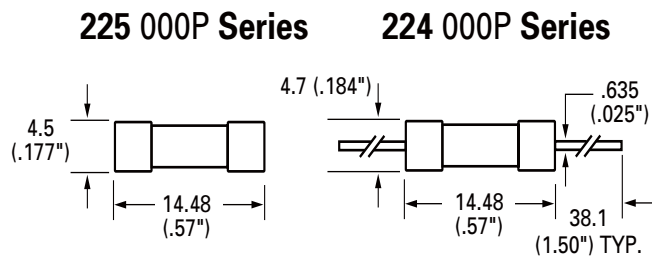
Note: These devices are not recommended for IR or Convection Reflow process.

Product Characteristics

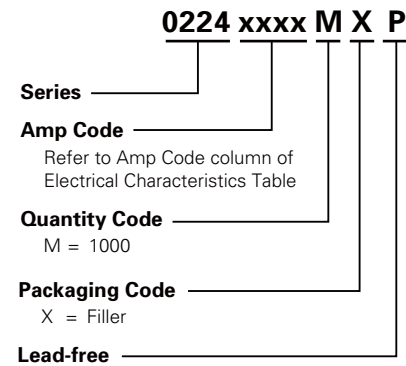
Materials	Body : Glass Cap : Nickel-plated brass Leads: Tin-plated Copper
Terminal Strength	MIL-STD-202F Method 211A, Test Condition A
Solderability	Reference IEC 6012/Second Edition 2003-01 Annex A
Product Marking	Cap1 : Brand logo, current and Voltage Ratings Cap2 : Series and Agency approval Mark

Operating Temperature:	-55°C to +125°C
Thermal Shock:	MIL-STD-202F, Method 107G, Test Condition B (5 Cycles -65°C to +125°C).
Vibration	MIL-STD-202F, Method 201A
Humidity	MIL-STD-202F Method 103B, Test Condition A: High RH (95%) and elevated temp (40°C) for 240 hours
Salt Spray	MIL-STD-202F Method 101D, Test Condition B

Dimensions



Part Numbering System



Packaging

Packaging Option	Packaging Specification	Quantity	Quantity & Packaging Code	Taping Width
224 Series				
Bulk	N/A	5	VX	N/A
Bulk	N/A	5	VXU	N/A
Bulk	N/A	100	HX	N/A
Bulk	N/A	100	HXU	N/A
Bulk	N/A	1000	MX	N/A
Bulk	N/A	1000	MX250U	N/A
Bulk	N/A	1000	MXF16	N/A
Bulk	N/A	1000	MXF23	N/A
Bulk	N/A	1000	MXU	N/A
Reel and Tape	EIA 296-E	1500	DRT1	T1=52mm (2.062")
Reel and Tape	EIA 296-E	1500	DRT1U	T1=52mm (2.062")
Reel and Tape	EIA 296-E	1500	DRT2	T2=63mm (2.500")
Reel and Tape	EIA 296-E	1500	DRT3	T3=73mm (2.874")
Reel and Tape	EIA 296-E	2500	ERT1	T1=52mm (2.062")
Reel and Tape	EIA 296-E	2500	ERT2	T2=63mm (2.500")
Reel and Tape	EIA 296-E	2500	ERT3	T3=73mm (2.874")
Bulk	N/A	1000	MX50LE	N/A
225 Series				
Bulk	N/A	5	VX	N/A
Bulk	N/A	5	VXU	N/A
Bulk	N/A	100	HX	N/A
Bulk	N/A	100	HXU	N/A
Bulk	N/A	1000	MX	N/A
Bulk	N/A	1000	MXU	N/A